

## C0402C181GATAC7411

SMD Comm X8G HT150C, Ceramic, 180 pF, 2%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402, 0.3 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.06 mg
Shelf Life	78 Weeks
MSL	1

100 GOhms

	Specifications	
0402	Capacitance	180 pF
1mm +/-0.05mm	Measurement Condition	1 MHz 1.0Vrms
0.5mm +/-0.05mm	Tolerance	2%
0.5mm +/-0.05mm	Voltage DC	250 VDC
0.3mm MIN	Dielectric Withstanding Voltage	625 VDC
0.3mm +/-0.1mm	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
	Capacitance Change with	30 ppm/C, 1MegaHz 1.0Vrms
T&R, 330mm, Paper Tape	Reference to +25°C and 0 VDC Applied (TCC)	
50000	Dissipation Factor	0.1% 1 MHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours

Insulation Resistance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Dimensions

**Packaging Specifications** 

Packaging Quantity

Chip Size

L W

Т

s

В

Packaging